

Plasma Profiling-TOFMS

New Fast Depth Profiling Technique



PP-TOFMS couples a glow discharge plasma to an ultra-fast time of flight mass spectrometer and provides chemical analysis of solid materials as function of depth.

◆ Fast and Direct analysis

A rapid erosion plasma combined with an ultrafast detection is the key to analyzing samples in minutes. In addition samples are measured directly without any preliminary preparation or transfer into a UHV chamber.

◆ All types of materials

The use of RF excitation permits the analysis of conductive and insulating, inorganics, organics, and hybrides materials or layers, e.g. thin layers on thick glass substrates.

◆ Full mass coverage

In contrast with sequential mass spectrometers, TOFMS offers full mass spectrum offering elemental (from H to U) and molecular information, including isotopic monitoring at any depth even for the thinnest layers.

◆ Unique 3D data

The glow discharge is operated in pulsed RF mode (patented) thanks to an innovative matching system combined with a high performance acquisition electronics and software. The temporal ion response over the RF source period is capitalised for high sensivity and to minimize isobaric interferences.

◆ High depth resolution

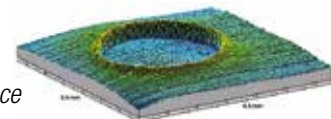
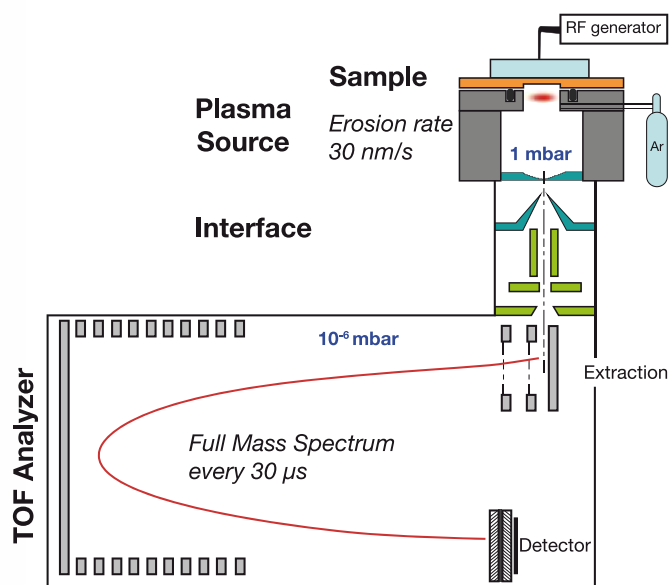
Despite the mm size crater formed, layers as thin as 1 nm are measured.

◆ Thin to thick layers

The high density plasma results in high sputtering rate and allows for measuring thick layers up to 100 μm .

◆ Semiquantitative analysis

Minimal matrix effects due to the separation of sputtering and ionisation processes in the discharge volume give the capability of a calibration free semiquantitative analysis.



Crater created on sample surface

Applications

- ◆ Nanostructures characterisation
- ◆ Dopants profiling
- ◆ Surface and bulk contaminants identification
- ◆ Corrosion science and technology

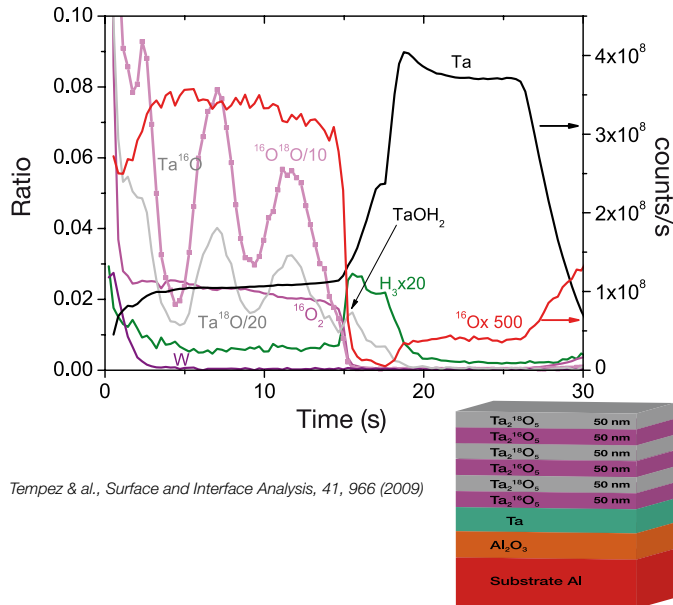


Specifications

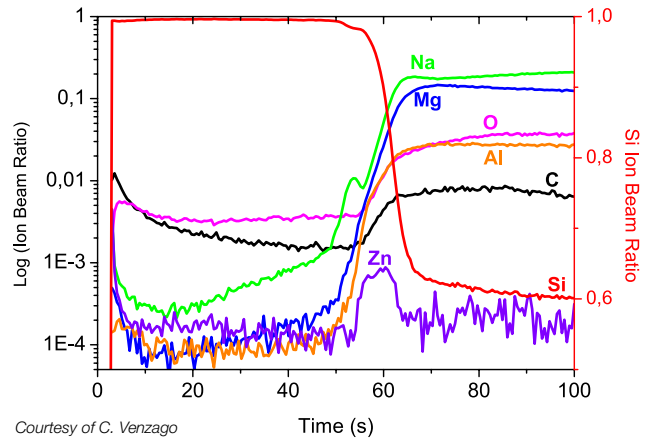
- ◆ Acquisition rate: 33 kHz to cover elements up to U (a full spectrum every 30 μ s)
- ◆ Mass Resolving power: 3500 at m/z 208
high resolution 5000 at m/z 208
- ◆ Dynamic range: 10^7
- ◆ Mass accuracy (m/z error / true m/z): 40 ppm
- ◆ Sensitivity: 10^3 cps/ppm
- ◆ Depth resolution: nm
- ◆ Both negative and positive ion modes
- ◆ Flexible blanking capability up to 4 ions
- ◆ Easy and horizontal sample mounting

Examples

Isotopic Profiling in ^{18}O enriched Tantalum Oxide

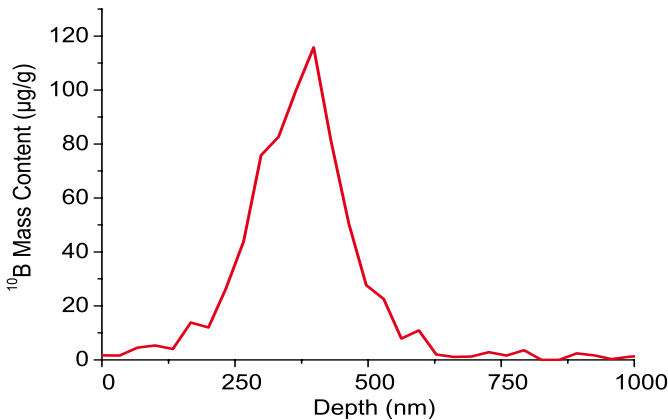


Impurities identification in Si PV



Quantitative implanted Boron in Si

100 keV $^{10}\text{B}^+$ - 10^{14} atom/cm 2 - Depth profile in 15 seconds



Mg in InGaN quantitative measurement

Up to mid 10^{18} at/cm 3 upon calibration

Sample	Electrolytic Capacitance Voltage	PP-TOFMS
A1	3.8×10^{20}	$3.9 \times 10^{20} \pm 2.1 \times 10^{19}$
A2	--	$4.0 \times 10^{20} \pm 2.8 \times 10^{19}$
A3	1.7×10^{20}	$2.6 \times 10^{20} \pm 1.3 \times 10^{19}$
A4	4.4×10^{18}	$4.6 \times 10^{18} \pm 1.6 \times 10^{18}$
A5	1.8×10^{20}	$2.1 \times 10^{20} \pm 1.0 \times 10^{19}$

Courtesy of Prof. Bensaoula, University of Houston

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